

# Global Memory Package Substrate Supply, Demand and Key Producers, 2026-2032

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## Abstracts

The global Memory Package Substrate market size is expected to reach \$ 2533 million by 2032, rising at a market growth of 5.1% CAGR during the forecast period (2026-2032).

Semiconductor package substrates (IC substrates) play an important role in protecting IC chips from the surrounding environment, ensuring electrical connection for chip mount on printed wiring boards. Demand for high-speed, high-integration and low power consumption of ICs accompanying the rapid progress of electronics technology such as AI, Cloud computing, Intelligentization of automobiles, and due to the miniaturization and thinning of electronic devices typified by smart phone and wearable devices, semiconductor packages are required further high density, multilayer, low-profile.

This report studies the IC substrates for memory (also called memory substrate), including WBCSP, WB-BGA, and FCCSP, used in DRAM (Volatile memory), NAND Flash (Solid-state Drive, Embedded Storage, and Mobile Memory).

Memory devices refer to components that store information using mediums such as magnetic materials or semiconductors. Semiconductor memory specifically leverages semiconductor materials to store electric charges for information retention, with storage and retrieval processes manifested as the charging or discharging of these materials. As a critical branch of integrated circuits, semiconductor memory plays an essential role in modern electronics.

With the exponential growth in data storage demands driven by modern electronic information systems, the shipment volume of semiconductor memory has been experiencing sustained and significant growth. Simultaneously, breakthroughs in

semiconductor wafer fabrication, aligned with Moore's Law, have consistently reduced the cost per unit of storage over the long term. As a result, despite short-term supply-demand fluctuations, the overall market scale exhibits a long-term growth trajectory.

Due to the tight integration of layout design and wafer manufacturing technologies, most leading semiconductor memory wafer manufacturers continue to operate under the IDM (Integrated Device Manufacturer) model. However, the IC packaging substrate market for memory devices is relatively fragmented and highly competitive. Key players in this sector are primarily located in regions such as China Taiwan, South Korea, Japan, and Mainland China. Representative companies include Unimicron Technology, Nanya PCB, Shinko Electric Industries, Samsung Electro-Mechanics, Zhen Ding Technology, Daeduck Electronics, LG InnoTek, Shennan Circuit, Shenzhen Fastprint Circuit Tech, and Shenzhen Hemei Jingyi Semiconductor Technology.

This report studies the global Memory Package Substrate production, demand, key manufacturers, and key regions.

This report is a detailed and comprehensive analysis of the world market for Memory Package Substrate and provides market size (US\$ million) and Year-over-Year (YoY) Growth, considering 2025 as the base year. This report explores demand trends and competition, as well as details the characteristics of Memory Package Substrate that contribute to its increasing demand across many markets.

### **Highlights and key features of the study**

Global Memory Package Substrate total production and demand, 2021-2032, (K Sqm)

Global Memory Package Substrate total production value, 2021-2032, (USD Million)

Global Memory Package Substrate production by region & country, production, value, CAGR, 2021-2032, (USD Million) & (K Sqm), (based on production site)

Global Memory Package Substrate consumption by region & country, CAGR, 2021-2032 & (K Sqm)

U.S. VS China: Memory Package Substrate domestic production, consumption, key domestic manufacturers and share

Global Memory Package Substrate production by manufacturer, production, price, value and market share 2021-2026, (USD Million) & (K Sqm)

Global Memory Package Substrate production by Type, production, value, CAGR, 2021-2032, (USD Million) & (K Sqm)

Global Memory Package Substrate production by Application, production, value, CAGR, 2021-2032, (USD Million) & (K Sqm)

This report profiles key players in the global Memory Package Substrate market based on the following parameters - company overview, production, value, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include Unimicron, Samsung Electro-Mechanics, Nan Ya PCB, Shinko Electric Industries, Zhen Ding Technology, Daeduck Electronics, LG InnoTek, DAISHO DENSHI, Korea Circuit, Shennan Circuit, etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals.

Stakeholders would have ease in decision-making through various strategy matrices used in analyzing the World Memory Package Substrate market

### **Detailed Segmentation:**

Each section contains quantitative market data including market by value (US\$ Millions), volume (production, consumption) & (K Sqm) and average price (US\$/Sqm) by manufacturer, by Type, and by Application. Data is given for the years 2021-2032 by year with 2025 as the base year, 2026 as the estimate year, and 2027-2032 as the forecast year.

Global Memory Package Substrate Market, By Region:

United States

China

Europe

Japan

South Korea

ASEAN

India

Rest of World

### Global Memory Package Substrate Market, Segmentation by Type:

WB-CSP

WB-BGA

FCCSP

### Global Memory Package Substrate Market, Segmentation by Layer Count:

2–4 layers

4–6 layers

8+ layers

### Global Memory Package Substrate Market, Segmentation by Application:

Memory Modules

Solid-state Drive

Embedded Storage

Mobile Memory

### Companies Profiled:

Unimicron

Samsung Electro-Mechanics

Nan Ya PCB

Shinko Electric Industries

Zhen Ding Technology

Daeduck Electronics

LG InnoTek

DAISHO DENSHI

Korea Circuit

Shennan Circuit

Shenzhen Fastprint Circuit Tech

Shenzhen Hemei Jingyi Semiconductor Technology

Hong Yuen Electronics

Huizhou China Eagle Electronic Technology

### **Key Questions Answered:**

1. How big is the global Memory Package Substrate market?
2. What is the demand of the global Memory Package Substrate market?
3. What is the year over year growth of the global Memory Package Substrate market?
4. What is the production and production value of the global Memory Package Substrate market?
5. Who are the key producers in the global Memory Package Substrate market?
6. What are the growth factors driving the market demand?

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